

OKI Semiconductor

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MR27V1602D

1,048,576-Word x 16-Bit or 2,097,152-Word x 8-Bit
Production Programmed Read Only Memory (P2ROM)

DESCRIPTION

The MR27V1602D is a 16Mbit Production Programmed Read-Only Memory (P2ROM) whose configuration can be electrically switched between 1,048,576 word x 16bit and 2,097,152 word x 8 bit. The MR27V1602D operates on a single +3V-3.3V power supply and is TTL compatible. Since the MR27V1602D operates asynchronously, external clocks are not required, making this device easy-to-use. The MR27V1602D is suitable as large-capacity fixed memory for microcomputers and data terminals. It is manufactured using a CMOS double silicon gate technology and is offered in 42-pin DIP, 44-pin SOP, 44-pin TSOP or 48-pin TSOP packages.

FEATURES

- 1,048,576 word x 16bit / 2,097,152 word x 8bit electrically switchable configuration
 - Single +3V-3.3V power supply
 - Access time 90ns access time ($V_{cc} = +3V$)
 80ns access time ($V_{cc} = +3.3V$)
 - Input / Output TTL compatible
 - Three-state output
 - Packages

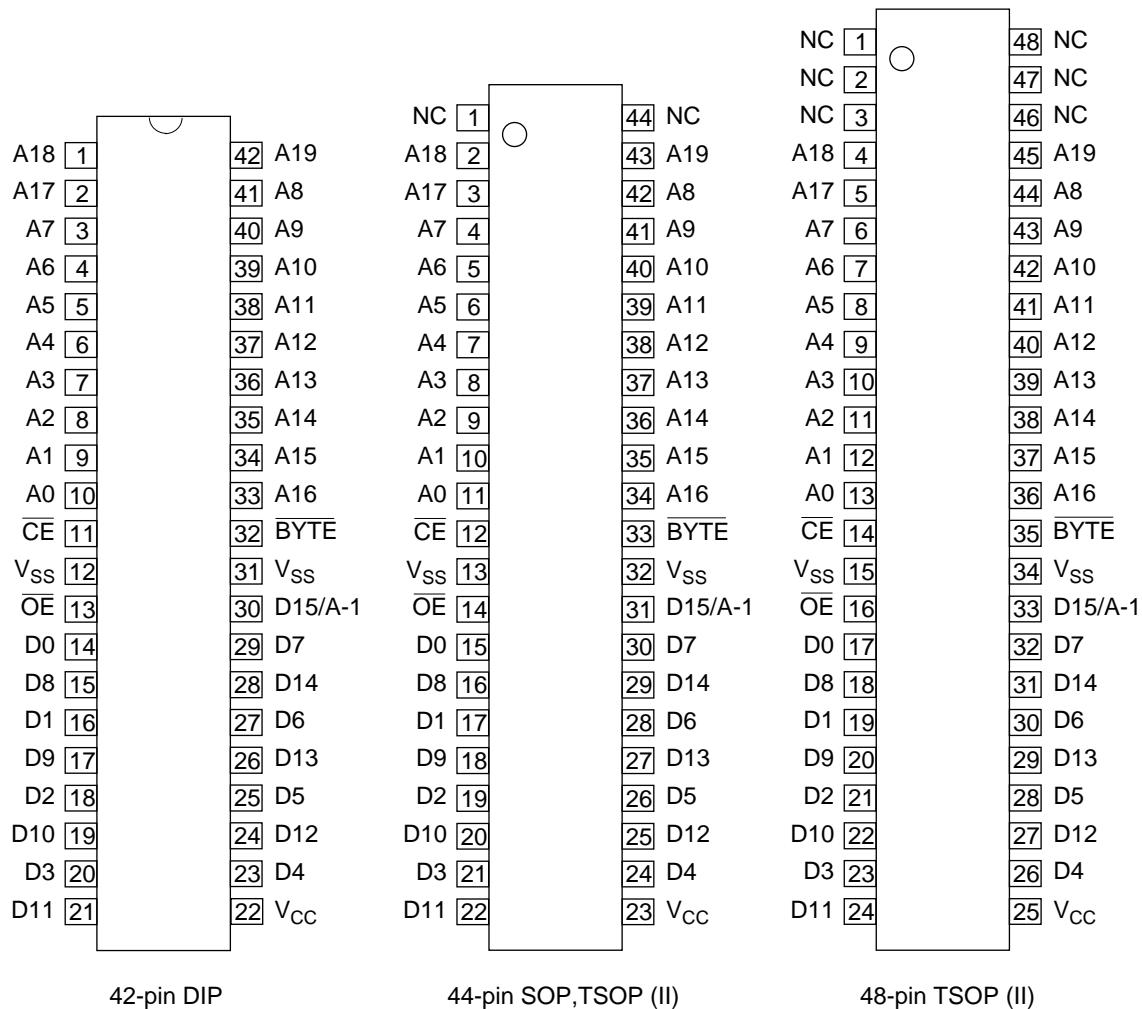
42-pin plastic DIP (DIP42-P-600-2.54) (Product name : MR27V1602D-xxRA)

44-pin plastic SOP (SOP44-P-600-1.27-K) (Product name : MR27V1602D-xxMA)

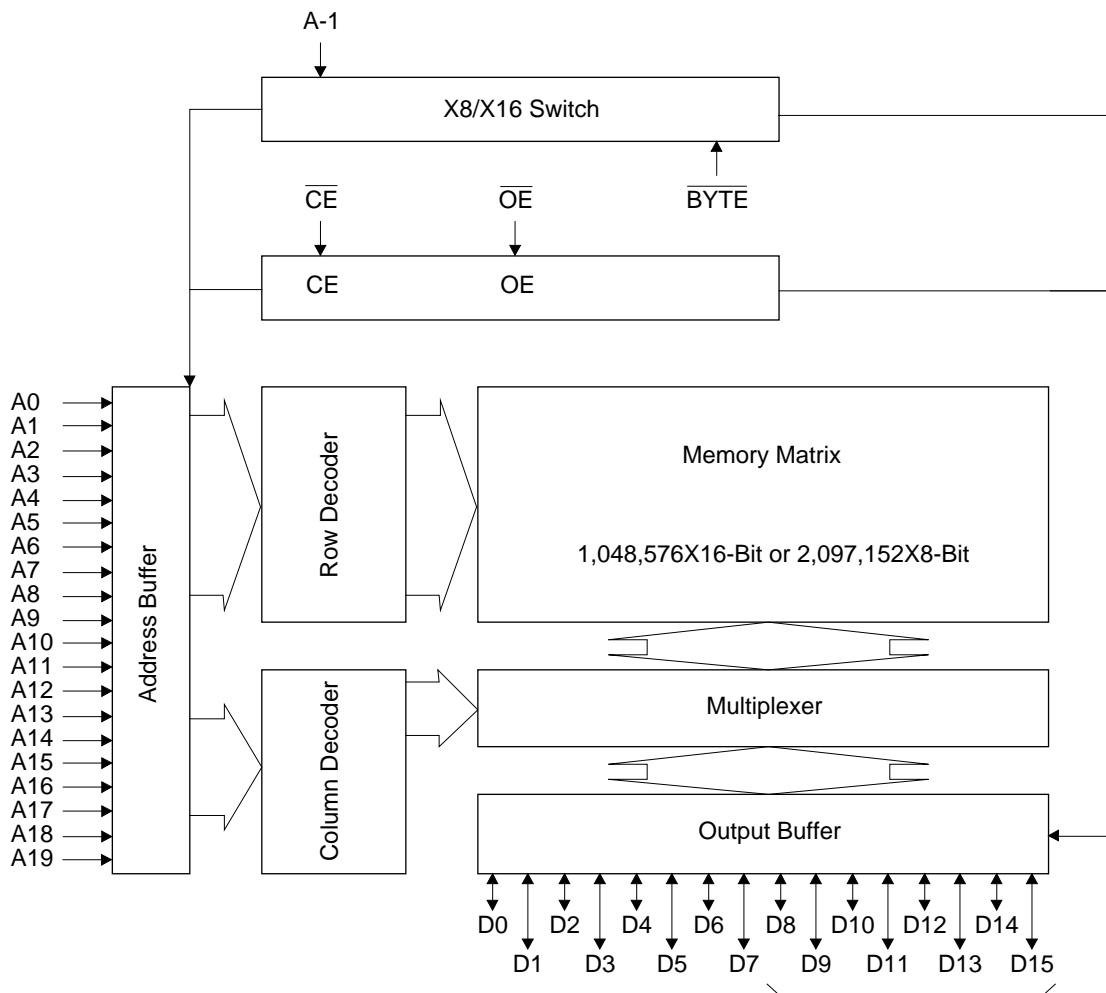
44-pin plastic TSOP (TSOP II 44-P-400-0.80-K) (Product name : MR27V1602D-xxTP)

48-pin plastic TSOP (TSOP II 48-P-550-0.80-K) (Product name : MR27V1602D-xxTA)

PIN CONFIGURATION (TOP VIEW)



PIN NAMES	FUNCTIONS
D15/A-1	Data output / Address input
A0-A19	Address input
D0-D14	Data output
CE	Chip enable
OE	Output enable
V _{CC}	Power supply voltage
V _{SS}	GND
BYTE	Mode switch
NC	Non connection

BLOCK DIAGRAM

In 8-bit output mode, these pins are three-stated and pin D15 functions as the A-1 address pin.

FUNCTION TABLE

MODE	CE	OE	BYTE	V _{CC}	D0 - D7	D8 - D14	D15/A-1
READ (16-Bit)	L	L	H	3.0V to 3.3V	D _{OUT}		
READ (8-Bit)	L	L	L		D _{OUT}	Hi-Z	L/H
OUTPUT DISABLE	L	H	H		Hi-Z		
			L		*		
STAND-BY	H	*	H		Hi-Z		
			L		*		

*: Don't Care

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Value	Unit
Operating temperature under bias	T_{opr}	-	0 to 70	°C
Storage temperature	T_{stg}		-55 to 125	°C
Input voltage	V_I	relative to V _{SS}	-0.5 to $V_{CC} + 0.5$	V
Output voltage	V_O		-0.5 to $V_{CC} + 0.5$	V
Power supply voltage	V_{CC}		-0.5 to 5	V
Power dissipation per package	P_D	-	1.0	W

RECOMMENDED OPERATING CONDITIONS

(Ta=0 to 70°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
V_{CC} power supply voltage	V_{CC}	$V_{CC}=2.7V\text{-}3.6V$	2.7	-	3.6	V
Input "H" level	V_{IH}		2.2	-	$V_{CC}+0.5^*$	V
Input "L" level	V_{IL}		-0.5**	-	0.6	V

Voltage is relative to V_{SS}* : $V_{CC}+1.5V$ (Max.) when pulse width of overshoot is less than 10nS.

** : -1.5V (Min.) when pulse width of undershoot is less than 10nS.

ELECTRICAL CHARACTERISTICS (Read operation)

DC Characteristics 1

(V _{CC} =3V±0.3V, Ta=0 to 70°C)						
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input leakage current	I _{LI}	V _I =0 to V _{CC}	-	-	10	µA
Output leakage current	I _{LO}	V _O =0 to V _{CC}	-	-	10	µA
V _{CC} power supply current (Standby)	I _{CCSC}	CE=V _{CC}	-	-	50	µA
	I _{CCST}	CE=V _{IH}	-	-	1	mA
V _{CC} power supply current (Read)	I _{CCA}	CE=V _{IL} , OE=V _{IH} tc=90ns	-	-	35	mA
Input "H" level	V _{IH}	-	2.2	-	V _{CC} +0.5*	V
Input "L" level	V _{IL}	-	-0.5**	-	0.6	V
Output "H" level	V _{OH}	I _{OH} =-400µA	2.4	-	-	V
Output "L" level	V _{OL}	I _{OL} =2.1mA	-	-	0.4	V

Voltage is relative to Vss

* : Vcc+1.5V (Max.) when pulse width of overshoot is less than 10nS.

** : -1.5V (Min.) when pulse width of undershoot is less than 10nS.

DC Characteristics 2

(V _{CC} =3.3V±0.3V, Ta=0 to 70°C)						
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input leakage current	I _{LI}	V _I =0 to V _{CC}	-	-	10	µA
Output leakage current	I _{LO}	V _O =0 to V _{CC}	-	-	10	µA
V _{CC} power supply current (Standby)	I _{CCSC}	CE=V _{CC}	-	-	50	µA
	I _{CCST}	CE=V _{IH}	-	-	1	mA
V _{CC} power supply current (Read)	I _{CCA}	CE=V _{IL} , OE=V _{IH} tc=80ns	-	-	40	mA
Input "H" level	V _{IH}	-	2.2	-	V _{CC} +0.5*	V
Input "L" level	V _{IL}	-	-0.5**	-	0.6	V
Output "H" level	V _{OH}	I _{OH} =-400µA	2.4	-	-	V
Output "L" level	V _{OL}	I _{OL} =2.1mA	-	-	0.4	V

Voltage is relative to Vss

* : Vcc+1.5V (Max.) when pulse width of overshoot is less than 10nS.

** : -1.5V (Min.) when pulse width of undershoot is less than 10nS.

AC Characteristics 1(V_{CC}=3V±0.3V, Ta=0 to 70°C)

Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	T _C	-	90	-	ns
Address access time	T _{ACC}	$\overline{CE}=\overline{OE}=V_{IL}$	-	90	ns
\overline{CE} access time	T _{CE}	$\overline{OE}=V_{IL}$	-	90	ns
\overline{OE} access time	T _{OE}	$\overline{CE}=V_{IL}$	-	45	ns
Output disable time	T _{CHZ}	$\overline{OE}=V_{IL}$	0	30	ns
	T _{OHZ}	$\overline{CE}=V_{IL}$	0	25	ns
Output hold time	T _{OH}	$\overline{CE}=\overline{OE}=V_{IL}$	0	-	ns

Measurement conditions

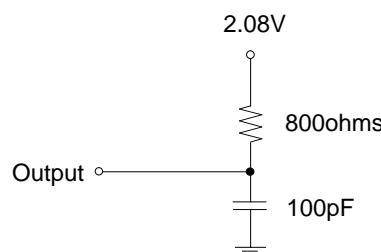
Input signal level ----- 0V/3V
 Input timing reference level ----- 0.8V/2.0V
 Output load ----- 100pF
 Output timing reference level ----- 0.8V/2.0V

AC Characteristics 2(V_{CC}=3.3V±0.3V, Ta=0 to 70°C)

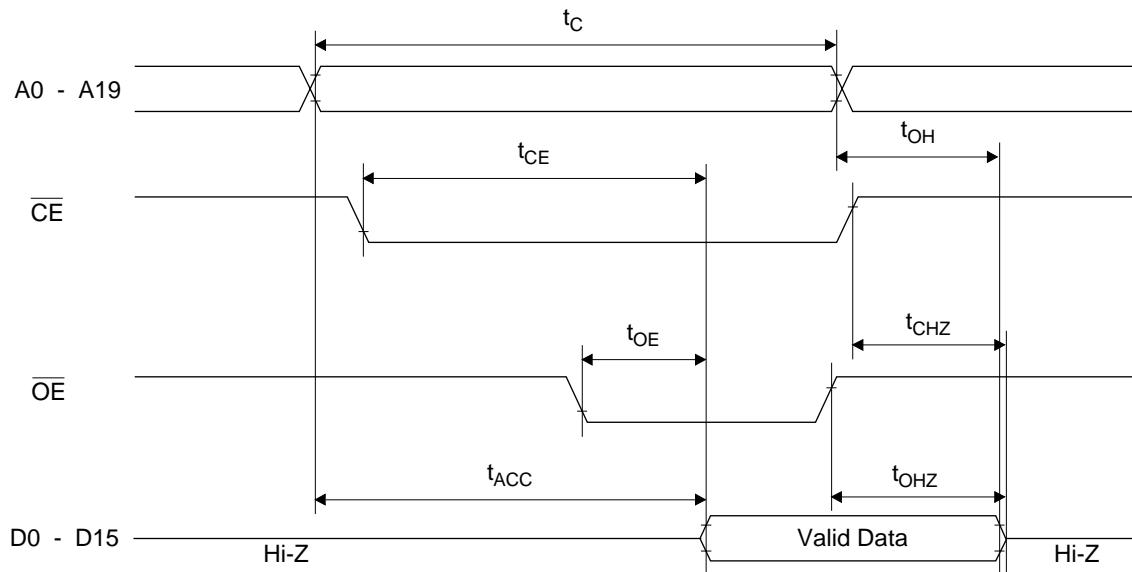
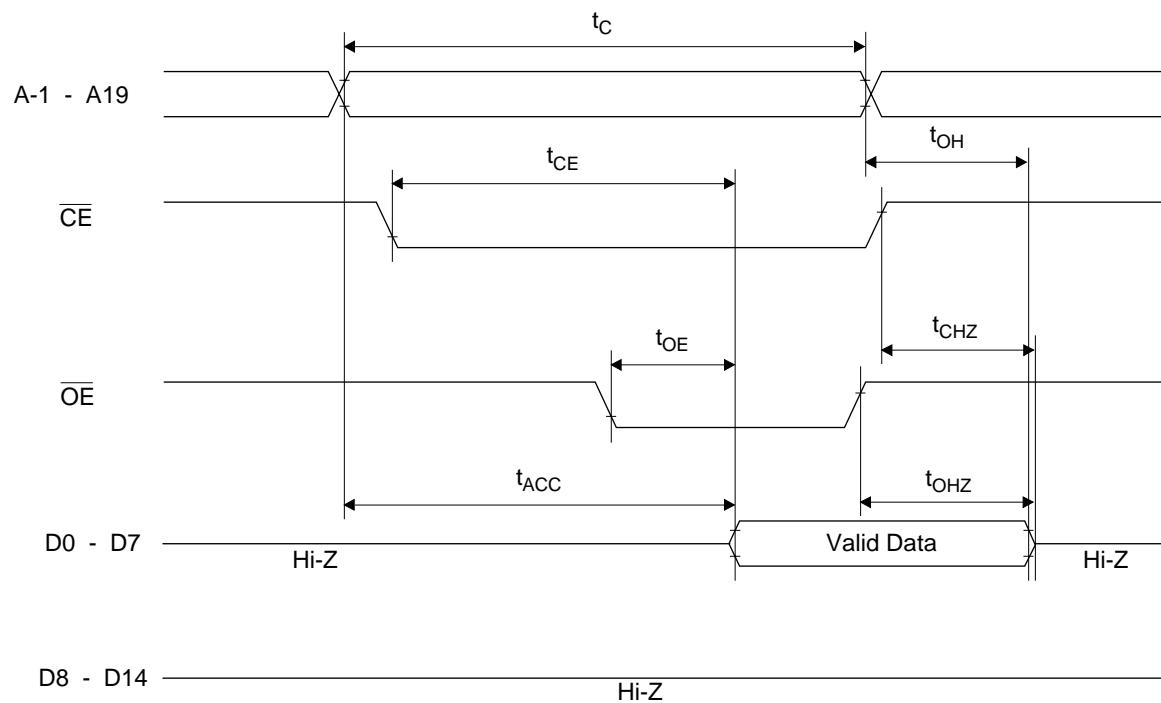
Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	T _C	-	80	-	ns
Address access time	T _{ACC}	$\overline{CE}=\overline{OE}=V_{IL}$	-	80	ns
\overline{CE} access time	T _{CE}	$\overline{OE}=V_{IL}$	-	80	ns
\overline{OE} access time	T _{OE}	$\overline{CE}=V_{IL}$	-	40	ns
Output disable time	T _{CHZ}	$\overline{OE}=V_{IL}$	0	30	ns
	T _{OHZ}	$\overline{CE}=V_{IL}$	0	25	ns
Output hold time	T _{OH}	$\overline{CE}=\overline{OE}=V_{IL}$	0	-	ns

Measurement conditions

Input signal level ----- 0V/3V
 Input timing reference level ----- 0.8V/2.0V
 Output load ----- 100pF
 Output timing reference level ----- 0.8V/2.0V



TIMING CHART (READ CYCLE)

16-Bit Read Mode ($\overline{\text{BYTE}}=V_{IH}$)8-Bit Read Mode ($\overline{\text{BYTE}}=V_{IL}$)

PIN Capacitance(V_{CC}=3.3V, Ta=25°C, f=1MHz)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input	C _{IN1}	V _I =0V	-	-	8 (10)	pF
BYTE	C _{IN2}		-	-	120	
Output	C _{OUT}	V _O =0V	-	-	10 (12)	

() : DIP only